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INFORMATION DISCLOSURE STATEMENT BY APPLICANT

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| Substitute for form 1449A/PTO | | Complete If Known | |
| INFORMATION DISCLOSURE STATEMENT BY APPLICANT <i>(use as many sheets as necessary)</i> | | Application Number | 10/764,587 |
| | | Filing Date | 01/27/2004 |
| | | First Named Inventor | Yasuhiro HITOMI et al. |
| | | Group Art Unit | |
| | | Examiner Name | |
| Sheet | 1 | of | 1 |
| | | Attorney Docket Number | SN-US030011 |

U.S. PATENT DOCUMENTS

FOREIGN PATENT DOCUMENTS

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